Dual supply translating transceiver; 3-state Rev. 6 — 6 August 2012

Product data sheet

General description 1.

The 74LVC1T45; 74LVCH1T45 are single bit, dual supply transceivers with 3-state outputs that enable bidirectional level translation. They feature two 1-bit input-output ports (A and B), a direction control input (DIR) and dual supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied at any voltage between 1.2 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins A and DIR are referenced to $V_{CC(A)}$ and pin B is referenced to V_{CC(B)}. A HIGH on DIR allows transmission from A to B and a LOW on DIR allows transmission from B to A.

The devices are fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either $V_{CC(A)}$ or $V_{CC(B)}$ are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH1T45 holds unused or floating data inputs at a valid logic level.

Features and benefits 2.

- Wide supply voltage range:
 - V_{CC(A)}: 1.2 V to 5.5 V
 - V_{CC(B)}: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - CDM JESD22-C101E exceeds 1000 V
- Maximum data rates:
 - 420 Mbps (3.3 V to 5.0 V translation)
 - 210 Mbps (translate to 3.3 V))
 - 140 Mbps (translate to 2.5 V)
 - 75 Mbps (translate to 1.8 V)
 - 60 Mbps (translate to 1.5 V)
- Suspend mode



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- Latch-up performance exceeds 100 mA per JESD 78 Class II
- ± 24 mA output drive (V_{CC} = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 16 μA maximum I_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

3. Ordering information

Type number	Package						
	Temperature range Name		Description	Version			
74LVC1T45GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74LVCH1T45GW							
74LVC1T45GM	–40 °C to +125 °C			SOT886			
74LVCH1T45GM			6 terminals; body $1 \times 1.45 \times 0.5$ mm				
74LVC1T45GF	–40 °C to +125 °C	XSON6	(SON6 plastic extremely thin small outline package; no leads;				
74LVCH1T45GF			6 terminals; body $1 \times 1 \times 0.5$ mm				
74LVC1T45GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads;	SOT1115			
74LVCH1T45GN			6 terminals; body $0.9 \times 1.0 \times 0.35$ mm				
74LVC1T45GS	–40 °C to +125 °C	XSON6	ON6 extremely thin small outline package; no leads;				
74LVCH1T45GS			6 terminals; body $1.0 \times 1.0 \times 0.35$ mm				

4. Marking

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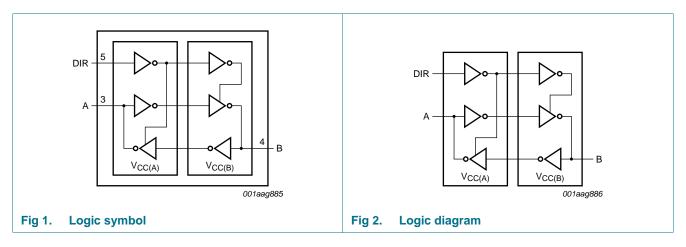
Table 2. Marking	
Type number	Marking code ^[1]
74LVC1T45GW	V5
74LVCH1T45GW	X5
74LVC1T45GM	V5
74LVCH1T45GM	X5
74LVC1T45GF	V5
74LVCH1T45GF	X5
74LVC1T45GN	V5
74LVCH1T45GN	X5
74LVC1T45GS	V5
74LVCH1T45GS	X5

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.



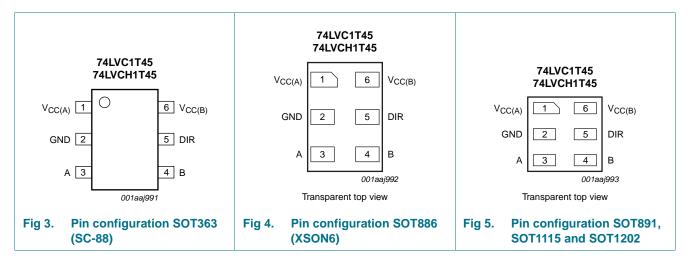
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

SymbolPinDescriptionV _{CC(A)} 1supply voltage port A and DIRGND2ground (0 V)A3data input or outputB4data input or outputDIR5direction controlV _{CC(B)} 6supply voltage port B	Table 3.	Pin description	
GND2ground (0 V)A3data input or outputB4data input or outputDIR5direction control	Symbol	Pin	Description
A3data input or outputB4data input or outputDIR5direction control	V _{CC(A)}	1	supply voltage port A and DIR
B4data input or outputDIR5direction control	GND	2	ground (0 V)
DIR 5 direction control	А	3	data input or output
	В	4	data input or output
V _{CC(B)} 6 supply voltage port B	DIR	5	direction control
	V _{CC(B)}	6	supply voltage port B

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7. Functional description

Supply voltage	Input	Input/output ^[2]		
V _{CC(A)} , V _{CC(B)}	DIR	Α	В	
1.2 V to 5.5 V	L	A = B	input	
1.2 V to 5.5 V	Н	input	B = A	
GND ^[3]	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The input circuit of the data I/O is always active.

[3] When either $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			-		-
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6.5	V
V _{CC(B)}	supply voltage B		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> _0.5	V _{CCO} + 0.5	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CCO}	[2] _	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[4] _	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 6.5 V.

[4] For SC-88 package: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	5.5	V
V _{CC(B)}	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V

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	Recommended operating condition				
Symbol	Parameter	Conditions	Min	Max	Unit
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{CCO}	V
		Suspend or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CCI} = 1.2 V	[2] _	20	ns/V
		$V_{CCI} = 1.4 \text{ V} \text{ to } 1.95 \text{ V}$	-	20	ns/V
		V_{CCI} = 2.3 V to 2.7 V	-	20	ns/V
		$V_{CCI} = 3 V \text{ to } 3.6 V$	-	10	ns/V
		V_{CCI} = 4.5 V to 5.5 V	-	5	ns/V

Table 6. Recommended operating conditions ...continued

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

10. Static characteristics

Table 7.Typical static characteristics at T_{amb} = 25 °C

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> -	1.09	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> -	0.07	-	V
l _l	input leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V	[2] _	-	±1	μA
I _{BHL}	bus hold LOW current	A or B port; V_I = 0.42 V; V_{CCI} = 1.2 V	[2] _	19	-	μA
I _{BHH}	bus hold HIGH current	A or B port; $V_I = 0.78 \text{ V}$; $V_{CCI} = 1.2 \text{ V}$	[2] -	-19	-	μA
I _{BHLO}	bus hold LOW overdrive current	A or B port; $V_{CCI} = 1.2 V$	[2][3] _	19	-	μΑ
I _{BHHO}	bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 V$	[2][3] _	-19	-	μA
I _{OZ}	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u> -	-	±1	μΑ
I _{OFF}	power-off leakage current	A port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V	-	-	±1	μA
		B port; V ₁ or V _O = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V	-	-	±1	μΑ
CI	input capacitance	DIR input; $V_I = 0 V \text{ or } 3.3 V$; $V_{CC(A)} = V_{CC(B)} = 3.3 V$	-	2.2	-	pF
C _{I/O}	input/output capacitance	A and B port; suspend mode; V _O = 3.3 V or 0 V; V _{CC(A)} = V _{CC(B)} = 3.3 V	-	6.0	-	pF

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO}/I_{BHHO} when the input is in the range V_{IL} to V_{IH} .

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Symbol	Parameter	Conditions		–40 °C to +85 °C		–40 °C to +125 °C		Unit
				Min	Max	Min	Max	
/ _{IH}	HIGH-level input voltage	data input	<u>[1]</u>					
		V _{CCI} = 1.2 V		0.8V _{CCI}	-	0.8V _{CCI}	-	V
		V _{CCI} = 1.4 V to 1.95 V		0.65V _{CCI}	-	0.65V _{CCI}	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		0.7V _{CCI}	-	0.7V _{CCI}	-	V
		DIR input						
		V _{CCI} = 1.2 V		0.8V _{CC(A)}	-	0.8V _{CC(A)}	-	V
		$V_{CCI} = 1.4 \text{ V}$ to 1.95 V		0.65V _{CC(A)}	-	0.65V _{CC(A)}	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V}$ to 5.5 V		0.7V _{CC(A)}	-	0.7V _{CC(A)}	-	V
	LOW-level input voltage	data input	<u>[1]</u>					
		V _{CCI} = 1.2 V		-	0.2V _{CCI}	-	0.2V _{CCI}	V
		$V_{CCI} = 1.4 \text{ V} \text{ to } 1.95 \text{ V}$		-	0.35V _{CCI}	-	0.35V _{CCI}	V
		V_{CCI} = 2.3 V to 2.7 V		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V}$ to 5.5 V		-	0.3V _{CCI}	-	0.3V _{CCI}	V
		DIR input						
		V _{CCI} = 1.2 V		-	0.2V _{CC(A)}	-	0.2V _{CC(A)}	V
		$V_{CCI} = 1.4 \text{ V to } 1.95 \text{ V}$		-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		V_{CCI} = 2.3 V to 2.7 V		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CC(A)}	-	0.3V _{CC(A)}	V
V _{он}	HIGH-level	$V_{I} = V_{IH}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CCO} = 1.2 \ V \text{ to } 4.5 \ V$	[2]	V _{CCO} - 0.1	-	$V_{CCO}-0.1$	-	V
		$I_0 = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		1.2	-	1.2	-	V
		$I_0 = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		1.9	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		2.4	-	2.4	-	V

Table 8. **Static characteristics**

 $I_0 = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$

3.8

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3.8

V

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Symbol	Parameter	Conditions		-40 °C te	o +85 °C	-40 °C to	+125 °C	Uni
			Ī	Min	Max	Min	Max	
/ _{OL}	LOW-level	$V_{I} = V_{IL}$	[2]					
	output voltage	I _O = 100 μA; V _{CCO} = 1.2 V to 4.5 V		-	0.1	-	0.1	V
		$I_0 = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_0 = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I	input leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V		-	±2	-	±10	μA
BHL	bus hold LOW	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.49 \text{ V}; V_{CCI} = 1.4 \text{ V}$		15	-	10	-	μΑ
		$V_{I} = 0.58 \text{ V}; V_{CCI} = 1.65 \text{ V}$		25	-	20	-	μΑ
		$V_{I} = 0.70 \text{ V}; V_{CCI} = 2.3 \text{ V}$		45	-	45	-	μA
		$V_{I} = 0.80 \text{ V}; V_{CCI} = 3.0 \text{ V}$		100	-	80	-	μA
		$V_{I} = 1.35 \text{ V}; V_{CCI} = 4.5 \text{ V}$		100	-	100	-	μA
BHH	bus hold HIGH	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.91 \text{ V}; V_{CCI} = 1.4 \text{ V}$		-15	-	-10	-	μA
		$V_{I} = 1.07 \text{ V}; V_{CCI} = 1.65 \text{ V}$		-25	-	-20	-	μA
		$V_{I} = 1.60 \text{ V}; V_{CCI} = 2.3 \text{ V}$		-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μA
		$V_{I} = 3.15 \text{ V}; V_{CCI} = 4.5 \text{ V}$		-100	-	-100	-	μA
BHLO	bus hold LOW	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		125	-	125	-	μA
	current	V _{CCI} = 1.95 V		200	-	200	-	μA
		$V_{CCI} = 2.7 V$		300	-	300	-	μA
		V _{CCI} = 3.6 V		500	-	500	-	μA
		$V_{CCI} = 5.5 V$		900	-	900	-	μA
BHHO	bus hold HIGH	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		-125	-	-125	-	μA
	Garrent	V _{CCI} = 1.95 V		-200	-	-200	-	μA
		$V_{CCI} = 2.7 V$		-300	-	-300	-	μA
		$V_{CCI} = 3.6 V$		-500	-	-500	-	μΑ
		$V_{CCI} = 5.5 V$		-900	-	-900	-	μA
OZ	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	[2]	-	±2	-	±10	μA

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Symbol	Parameter	Conditions		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
I _{OFF}	power-off leakage current	A port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V	'	-	±2	-	±10	μA
		B port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	±2	-	±10	μΑ
I _{CC}	supply current	A port; $V_I = 0 V \text{ or } V_{CCI}$; $I_O = 0 A$	[1]					
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	8	-	8	μΑ
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	3	-	3	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 5.5 V$		-2	-	-2	-	μA
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A						
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V		-	8	-	8	μA
		$V_{CC(A)},~V_{CC(B)}$ = 1.65 V to 5.5 V		-	3	-	3	μA
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(B)} = 0 V; V_{CC(A)} = 5.5 V$		-2	-	-2	-	μΑ
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI}						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	16	-	16	μA
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	4	-	4	μA
ΔI_{CC}	additional	$V_{CC(A)},V_{CC(B)}$ = 3.0 V to 5.5 V						
	supply current	A port; A port at $V_{CC(A)} - 0.6$ V; DIR at $V_{CC(A)}$; B port = open	<u>[4]</u>	-	50	-	75	μΑ
		DIR input; DIR at $V_{CC(A)} - 0.6$ V; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μΑ
		B port; B port at $V_{CC(B)} - 0.6$ V; DIR at GND; A port = open	<u>[4]</u>	-	50	-	75	μΑ

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO}/I_{BHHO} when the input is in the range V_{IL} to V_{IH} .

[4] For non bus hold parts only (74LVC1T45).

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11. Dynamic characteristics

Table 9.

Table 9.Typical dynamic characteristics at $V_{CC(A)} = 1.2$ V and $T_{amb} = 25$ °CVoltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 8</u>; for waveforms see <u>Figure 6</u> and <u>Figure 7</u>

Symbol	Parameter	Conditions			Vco	C(B)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	8.1	7.0	5.8	5.3	5.1	ns
	propagation delay	B to A	10.6	9.5	9.0	8.5	8.3	8.2	ns
t _{PHL}	HIGH to LOW	A to B	10.1	7.1	6.0	5.3	5.2	5.4	ns
	propagation delay	B to A	10.1	8.6	8.1	7.8	7.6	7.6	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	9.4	9.4	9.4	9.4	9.4	ns
	propagation delay	DIR to B	12.0	9.4	9.0	7.8	8.4	7.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	7.1	7.1	7.1	7.1	7.1	ns
	propagation delay	DIR to B	9.5	7.8	7.7	6.9	7.6	7.0	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	17.3	16.7	15.4	15.9	15.2	ns
	propagation delay	DIR to B [1]	17.7	15.2	14.1	12.9	12.4	12.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	22.1	18.0	17.1	15.6	16.0	15.5	ns
	propagation delay	DIR to B [1]	19.5	16.5	15.4	14.7	14.6	14.8	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

Table 10. Typical dynamic characteristics at $V_{CC(B)}$ = 1.2 V and T_{amb} = 25 $^{\circ}C$ Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for waveforms see Figure 6 and Figure 7

Symbol	Parameter	Conditions			V	CC(A)			Unit
			1.2	V 1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	9.5	9.0	8.5	8.3	8.2	ns
	propagation delay	B to A	10.6	8.1	7.0	5.8	5.3	5.1	ns
t _{PHL}	HIGH to LOW	A to B	10.1	8.6	8.1	7.8	7.6	7.6	ns
	propagation delay	B to A	10.1	7.1	6.0	5.3	5.2	5.4	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	6.5	5.7	4.1	4.1	3.0	ns
	propagation delay	DIR to B	12.0) 6.1	5.4	4.6	4.3	4.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	4.9	4.5	3.2	3.4	2.5	ns
	propagation delay	DIR to B	9.5	7.3	6.6	5.9	5.7	5.6	ns
t _{PZH}	OFF-state to HIGH	DIR to A	20.1	15.4	13.6	11.7	11.0	10.7	ns
	propagation delay	DIR to B	17.7	7 14.4	13.5	11.7	11.7	10.7	ns
t _{PZL}	OFF-state to LOW	DIR to A	22.	13.2	11.4	9.9	9.5	9.4	ns
	propagation delay	DIR to B	19.8	5 15.1	13.8	11.9	11.7	10.6	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

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Symbol	Parameter	Conditions		V _{CC(A)} ar	nd V _{CC(B)}		Unit
			1.8 V	2.5 V	3.3 V	5.5 V	
C _{PD}	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	2	3	3	4	pF
		A port: (direction B to A); B port: (direction A to B)	15	16	16	18	pF

Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C}$ [1][2] *Voltages are referenced to GND (ground = 0 V).*

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure 7

Symbol	Parameter	Conditions					Vcc	C(B)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V =	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.8	21.3	2.4	17.6	2.0	13.5	1.7	11.8	1.6	10.5	ns
	propagation delay	B to A	2.8	21.3	2.6	19.1	2.3	14.9	2.3	12.4	2.2	12.0	ns
t _{PHL}	HIGH to LOW	A to B	2.6	19.3	2.2	15.3	1.8	11.8	1.7	10.9	1.7	10.8	ns
	propagation delay	B to A	2.6	19.3	2.4	17.3	2.3	13.2	2.2	11.3	2.3	11.0	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	ns
	propagation delay	DIR to B	3.5	24.8	3.5	23.6	3.0	11.0	3.3	11.3	2.8	10.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	ns
	propagation delay	DIR to B	2.8	18.3	3.0	17.2	2.5	9.4	3.0	10.1	2.5	9.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	39.6	-	36.3	-	24.3	-	22.5	-	21.4	ns
	propagation delay	DIR to B [1]	-	32.7	-	29.0	-	24.9	-	23.2	-	21.9	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	44.1	-	40.9	-	24.2	-	22.6	-	21.3	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.0	-	30.5	-	29.6	-	29.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.6	19.1	2.2	17.7	2.2	9.3	1.7	7.2	1.4	6.8	ns
	propagation delay	B to A	2.4	17.6	2.2	17.7	2.3	16.0	2.1	15.5	1.9	15.1	ns
t _{PHL}	HIGH to LOW	A to B	2.4	17.3	2.0	14.3	1.6	8.5	1.8	7.1	1.7	7.0	ns
	propagation delay	B to A	2.2	15.3	2.0	14.3	2.1	12.9	2.0	12.6	1.8	12.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	ns
	propagation delay	DIR to B	3.2	24.1	3.2	21.9	2.7	11.5	3.0	10.3	2.5	8.2	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	ns
	propagation delay	DIR to B	2.5	17.6	2.6	16.0	2.2	9.2	2.7	8.4	2.4	6.4	ns

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Symbol	Parameter	Conditio	าร					Vcc	С(В)					Uni
				1.5 V :	± 0.1 V	1.8 V 1	: 0.15 V	-		3.3 V :	± 0.3 V	5.0 V -	E 0.5 V	1
				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
PZH	OFF-state to HIGH	DIR to A	<u>[1]</u>	-	35.2	-	33.7	-	25.2	-	23.9	-	21.8	ns
	propagation delay	DIR to B	[1]	-	29.6	-	28.2	-	19.8	-	17.7	-	17.3	ns
PZL	OFF-state to LOW	DIR to A	[1]	-	39.4	-	36.2	-	24.4	-	22.9	-	20.4	ns
	propagation delay	DIR to B	[1]	-	34.4	-	31.4	-	25.6	-	24.2	-	24.1	ns
V _{CC(A)} =	2.3 V to 2.7 V													
PLH	LOW to HIGH	A to B		2.3	17.9	2.3	16.0	1.5	8.5	1.3	6.2	1.1	4.8	ns
	propagation delay	B to A		2.0	13.5	2.2	9.3	1.5	8.5	1.4	8.0	1.0	7.5	ns
PHL	HIGH to LOW	A to B		2.3	15.8	2.1	12.9	1.4	7.5	1.3	5.4	0.9	4.6	ns
	propagation delay	B to A		1.8	11.8	1.9	8.5	1.4	7.5	1.3	7.0	0.9	6.2	ns
PHZ	HIGH to OFF-state	DIR to A		2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	ns
	propagation delay	DIR to B		3.0	22.5	3.0	21.4	2.5	11.0	2.8	9.3	2.3	6.9	ns
PLZ	LOW to OFF-state	DIR to A		1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	ns
	propagation delay	DIR to B		2.3	14.6	2.5	13.2	2.0	9.0	2.5	8.4	1.8	5.3	ns
PZH	OFF-state to HIGH	DIR to A	[1]	-	28.1	-	22.5	-	17.5	-	16.4	-	12.8	ns
	propagation delay	DIR to B	[1]	-	23.7	-	21.8	-	14.3	-	12.0	-	10.6	ns
PZL	OFF-state to LOW	DIR to A	[1]	-	34.3	-	29.9	-	18.5	-	16.3	-	13.1	ns
	propagation delay	DIR to B	[1]	-	23.9	-	21.0	-	15.6	-	13.5	-	12.7	ns
V _{CC(A)} =	3.0 V to 3.6 V													
PLH	LOW to HIGH	A to B		2.3	17.1	2.1	15.5	1.4	8.0	0.8	5.6	0.7	4.4	ns
	propagation delay	B to A		1.7	11.8	1.7	7.2	1.3	6.2	0.7	5.6	0.6	5.4	ns
PHL	HIGH to LOW	A to B		2.2	15.6	2.0	12.6	1.3	7.0	0.8	5.0	0.7	4.0	ns
	propagation delay	B to A		1.7	10.9	1.8	7.1	1.3	5.4	0.8	5.0	0.7	4.5	ns
PHZ	HIGH to OFF-state	DIR to A		2.3	7.3	2.3	7.3	2.3	7.3	2.3	7.3	2.7	7.3	ns
	propagation delay	DIR to B		2.9	18.0	2.9	16.5	2.3	10.1	2.7	8.6	2.2	6.3	ns
PLZ	LOW to OFF-state propagation delay	DIR to A		2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	ns
		DIR to B		2.3	13.6	2.4	12.5	1.9	7.8	2.3	7.1	1.7	4.9	ns
PZH	OFF-state to HIGH propagation delay	DIR to A	[<u>1]</u>	-	25.4	-	19.7	-	14.0	-	12.7	-	10.3	ns
		DIR to B	[1]	-	22.7	-	21.1	-	13.6	-	11.2	-	10.0	ns
PZL	OFF-state to LOW propagation delay	DIR to A	[1]	-	28.9	-	23.6	-	15.5	-	13.6	-	10.8	ns
		DIR to B	[1]	-	22.9	-	19.9	-	14.3	-	12.3	-	11.3	ns
	4.5 V to 5.5 V			0.0	46.5	4.0	45 4	4.0		<u> </u>		0 -	• •	
PLH	LOW to HIGH propagation delay	A to B		2.2	16.6	1.9	15.1	1.0	7.5	0.7	5.4	0.5	3.9	ns
		B to A		1.6	10.5	1.4	6.8	1.0	4.8	0.7	4.4	0.5	3.9	ns
PHL	HIGH to LOW propagation delay	A to B		2.3	15.3	1.8	12.2	1.0	6.2	0.7	4.5	0.5	3.5	ns
		B to A		1.7	10.8	1.7	7.0	0.9	4.6	0.7	4.0	0.5	3.5	ns
PHZ	HIGH to OFF-state propagation delay	DIR to A		1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	ns
	propagation delay	DIR to B		2.9	17.3	2.9	16.1	2.3	9.7	2.7	8.0	2.5	5.7	ns

Table 12. Dynamic characteristics for temperature range $-40 \degree$ C to $+85 \degree$ C ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure

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Symbol	Parameter	Conditions					Vcc	;(B)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V ±	± 0.2 V	3.3 V ±	E 0.3 V	5.0 V ±	: 0.5 V	
			Min	Max	Min	Мах	Min	Мах	Min	Max	Min	Max	
t _{PLZ}	LOW to OFF-state	DIR to A	1.4	3.7	1.4	3.7	1.3	3.7	1.0	3.7	0.9	3.7	ns
	propagation delay	DIR to B	2.3	13.1	2.4	12.1	1.9	7.4	2.3	7.0	1.8	4.5	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	23.6	-	18.9	-	12.2	-	11.4	-	8.4	ns
	propagation delay	DIR to B [1]	-	20.3	-	18.8	-	11.2	-	9.1	-	7.6	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	28.1	-	23.1	-	14.3	-	12.0	-	9.2	ns
	propagation delay	DIR to B 🛄	-	20.7	-	17.6	-	11.6	-	9.9	-	8.9	ns

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C ... continued Voltages are referenced to GND (ground = 0 V): for test circuit see Figure 8: for wave forms see Figure 6 and Figure 7

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure 7

Symbol	Parameter	Conditions					Vcc	;(B)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V ±	E 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$V_{CC(A)} =$	1.4 V to 1.6 V	1											
t _{PLH}	LOW to HIGH	A to B	2.5	23.5	2.1	19.4	1.8	14.9	1.5	13.0	1.4	11.6	ns
	propagation delay	B to A	2.5	23.5	2.3	21.1	2.0	16.4	2.0	13.7	1.9	13.2	ns
t _{PHL}	HIGH to LOW	A to B	2.3	21.3	1.9	16.9	1.6	13.0	1.5	12.0	1.5	11.9	ns
	propagation delay	B to A	2.3	21.3	2.1	19.1	2.0	14.6	1.9	12.5	2.0	12.1	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	ns
	propagation delay	DIR to B	3.1	27.3	3.1	26.0	2.7	12.1	2.9	12.5	2.5	11.4	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	ns
	propagation delay	DIR to B	2.5	20.2	2.7	19.0	2.2	10.4	2.7	11.2	2.2	10.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	43.7	-	40.1	-	26.8	-	24.9	-	23.6	ns
	propagation delay	DIR to B [1]	-	36.1	-	32.0	-	27.5	-	25.6	-	24.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	48.6	-	45.1	-	26.7	-	25.0	-	23.5	ns
	propagation delay	DIR to B [1]	-	41.9	-	37.5	-	33.6	-	32.6	-	32.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.3	21.1	1.9	19.5	1.9	10.3	1.5	8.0	1.2	7.5	ns
	propagation delay	B to A	2.1	19.4	1.9	19.5	2.0	17.6	1.8	17.1	1.7	16.7	ns
t _{PHL}	HIGH to LOW	A to B	2.1	19.1	1.8	15.8	1.4	9.4	1.6	7.9	1.5	7.7	ns
	propagation delay	B to A	1.9	16.9	1.8	15.8	1.8	14.2	1.8	13.9	1.6	13.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	ns
	propagation delay	DIR to B	2.8	26.6	2.8	24.1	2.4	12.7	2.7	11.4	2.2	9.1	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	ns
	propagation delay	DIR to B	2.2	19.4	2.3	17.6	1.9	10.2	2.4	9.3	2.1	7.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	38.8	-	37.1	-	27.8	-	26.4	-	24.1	ns
	propagation delay	DIR to B [1]	-	32.7	-	31.1	-	21.9	-	19.6	-	19.1	ns

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Symbol	Parameter	Conditions					Vcc	(В)					Uni
			1.5 V	± 0.1 V	1.8 V ±	0.15 V	2.5 V :		3.3 V :	± 0.3 V	5.0 V -	± 0.5 V	-
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	-
PZL	OFF-state to LOW	DIR to A [1]	-	43.5	-	39.9	-	26.9	-	25.3	-	22.6	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.7	-	28.3	-	26.8	-	26.6	ns
V _{CC(A)} =	2.3 V to 2.7 V												
t _{PLH}	LOW to HIGH	A to B	2.0	19.7	2.0	17.6	1.3	9.4	1.1	6.9	0.9	5.3	ns
	propagation delay	B to A	1.8	14.9	1.9	10.3	1.3	9.4	1.2	8.8	0.9	8.3	ns
PHL	HIGH to LOW	A to B	2.0	17.4	1.8	14.2	1.2	8.3	1.1	6.0	0.8	5.1	ns
	propagation delay	B to A	1.6	13.0	1.7	9.4	1.2	8.3	1.1	7.7	0.8	6.9	ns
PHZ	HIGH to OFF-state	DIR to A	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	ns
	propagation delay	DIR to B	2.7	24.8	2.7	23.6	2.2	12.1	2.5	10.3	2.0	7.6	ns
PLZ	LOW to OFF-state	DIR to A	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	ns
	propagation delay	DIR to B	2.0	16.1	2.2	14.6	1.8	9.9	2.2	9.3	1.6	5.9	ns
PZH	OFF-state to HIGH	DIR to A [1]	-	31.0	-	24.9	-	19.3	-	18.1	-	14.2	ns
	propagation delay	DIR to B	-	26.1	-	24.0	-	15.8	-	13.3	-	11.7	ns
PZL	OFF-state to LOW	DIR to A [1]	-	37.8	-	33.0	-	20.4	-	18.0	-	14.5	ns
	propagation delay	DIR to B	-	26.4	-	23.2	-	17.3	-	15.0	-	14.1	ns
/ _{CC(A)} =	3.0 V to 3.6 V												
PLH	LOW to HIGH	A to B	2.0	18.9	1.8	17.1	1.2	8.8	0.7	6.2	0.6	4.9	ns
	propagation delay	B to A	1.5	13.0	1.5	8.0	1.1	6.9	0.6	6.2	0.5	6.0	ns
PHL	HIGH to LOW	A to B	1.9	17.2	1.8	13.9	1.1	7.7	0.7	5.5	0.6	4.4	ns
	propagation delay	B to A	1.5	12.0	1.6	7.9	1.1	6.0	0.7	5.5	0.6	5.0	ns
PHZ	HIGH to OFF-state	DIR to A	2.0	8.1	2.0	8.1	2.0	8.1	2.0	8.1	2.4	8.1	ns
	propagation delay	DIR to B	2.6	19.8	2.6	18.2	2.0	11.2	2.4	9.5	1.9	7.0	ns
PLZ	LOW to OFF-state	DIR to A	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	ns
	propagation delay	DIR to B	2.0	15.0	2.1	13.8	1.7	8.6	2.0	7.9	1.5	5.4	ns
PZH	OFF-state to HIGH	DIR to A [1]	-	28.0	-	21.8	-	15.5	-	14.1	-	11.4	ns
	propagation delay	DIR to B [1]	-	25.1	-	23.3	-	15.0	-	12.4	-	11.1	ns
PZL	OFF-state to LOW	DIR to A [1]	-	31.8	-	26.1	-	17.2	-	15.0	-	12.0	ns
	propagation delay	DIR to B [1]	-	25.3	-	22.0	-	15.8	-	13.6	-	12.5	ns
$V_{CC(A)} =$	4.5 V to 5.5 V												
PLH	LOW to HIGH	A to B	1.9	18.3	1.7	16.7	0.9	8.3	0.6	6.0	0.4	4.3	ns
	propagation delay	B to A	1.4	11.6	1.2	7.5	0.9	5.3	0.6	4.9	0.4	4.3	ns
PHL	HIGH to LOW	A to B	2.0	16.9	1.6	13.5	0.9	6.9	0.6	5.0	0.4	3.9	ns
	propagation delay	B to A	1.5	11.9	1.5	7.7	0.8	5.1	0.6	4.4	0.4	3.9	ns
PHZ	HIGH to OFF-state	DIR to A	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	ns
	propagation delay	DIR to B	2.6	19.1	2.6	17.8	2.0	10.7	2.4	8.8	2.2	6.3	ns
PLZ	LOW to OFF-state	DIR to A	1.2	4.1	1.2	4.1	1.1	4.1	0.9	4.1	0.8	4.1	ns
	propagation delay	DIR to B	2.0	14.5	2.1	13.4	1.7	8.2	2.0	7.7	1.6	5.0	ns

 Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C ...continued

 Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure

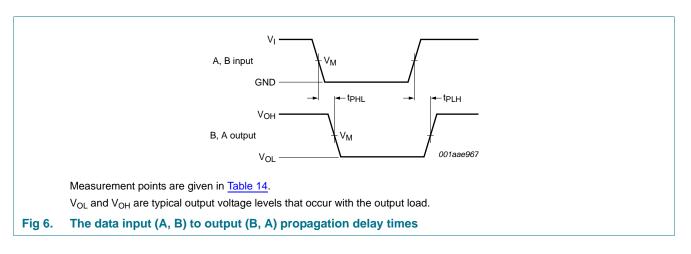
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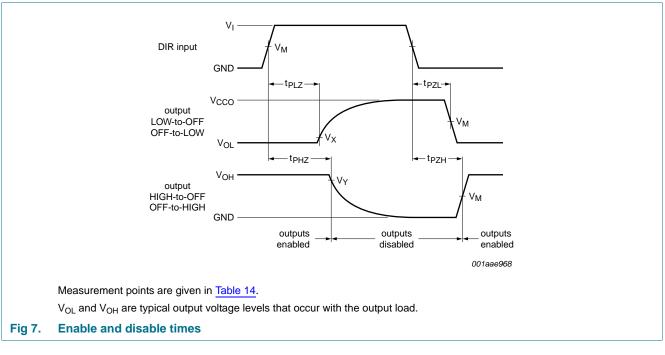
Symbol	Parameter	Conditions					Vcc	с(В)					Unit
			1.5 V	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V ±	E 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t _{PZH}	OFF-state to HIGH	DIR to A	1 -	26.1	-	20.9	-	13.5	-	12.6	-	9.3	ns
	propagation delay	DIR to B	1 -	22.4	-	20.8	-	12.4	-	10.1	-	8.4	ns
t _{PZL}	OFF-state to LOW	DIR to A	1 -	31.0	-	25.5	-	15.8	-	13.2	-	10.2	ns
	propagation delay	DIR to B]	22.9	-	19.5	-	12.9	-	11.0	-	9.9	ns

Table 13 Dynamic characteristics for temperature range -40 °C to +125 °C continued

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times"

12. Waveforms





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Table 14.Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
V _{CC(A)} , V _{CC(B)}	V _M	V _M	V _X	V _Y
1.2 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 5.5 V	0.5V _{CCI}	$0.5V_{CCO}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] $\,\,$ V_{CCO} is the supply voltage associated with the output port.

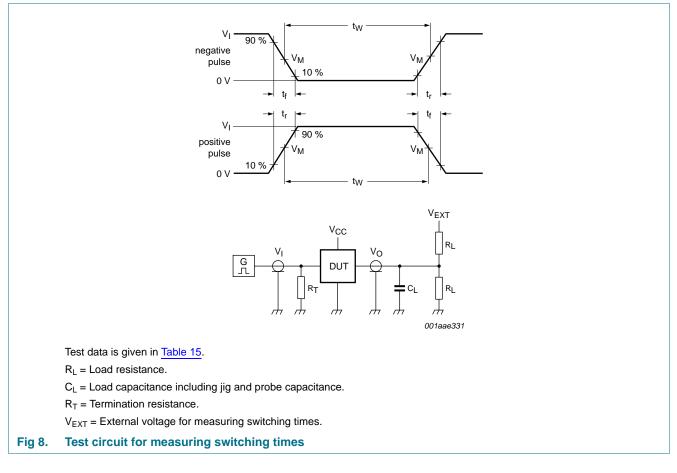


Table 15. Test data

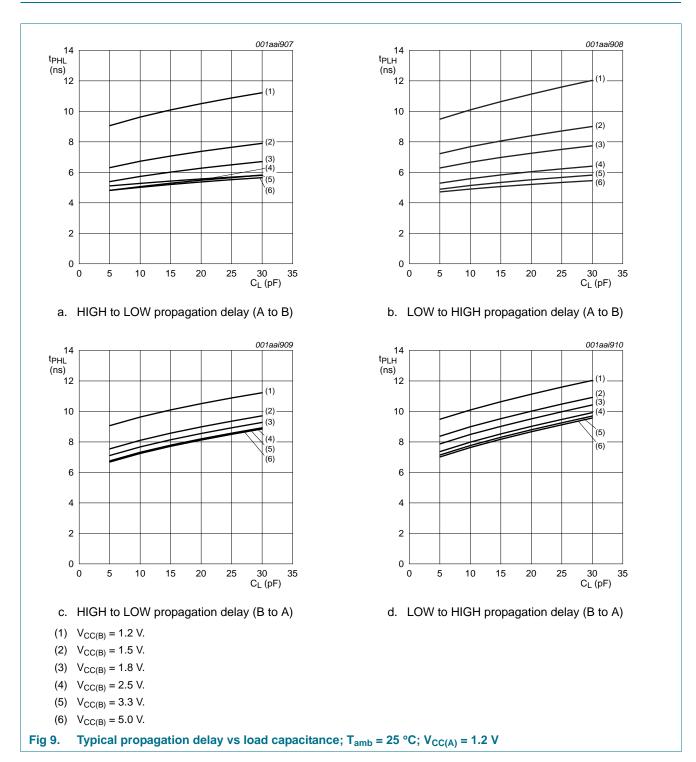
Supply voltage	Input		Load		V _{EXT}		
V _{CC(A)} , V _{CC(B)}	V [1]	Δt/ΔV ^[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
1.2 V to 5.5 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] $dV/dt \ge 1.0 V/ns$

[3] V_{CCO} is the supply voltage associated with the output port.

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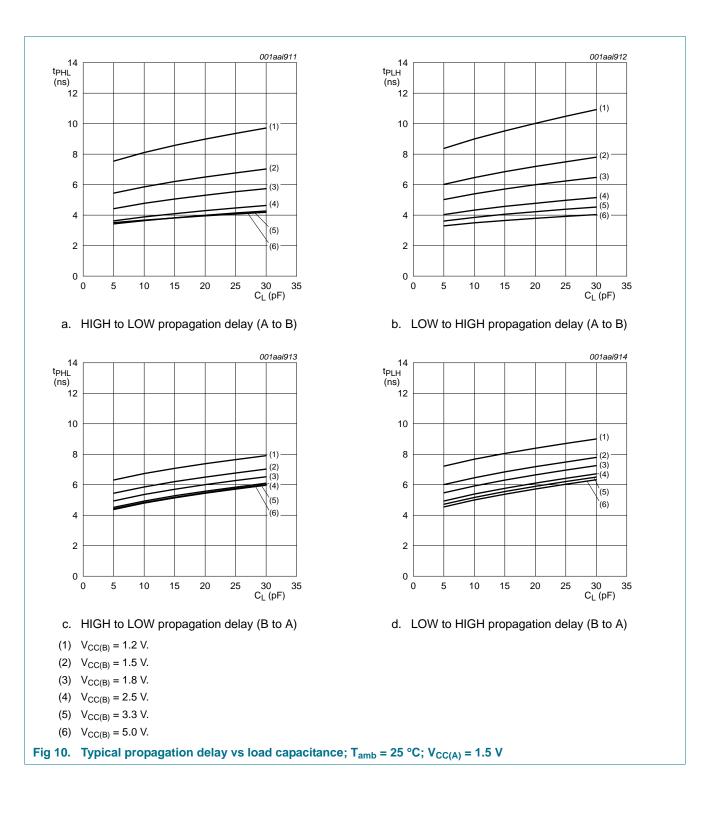


13. Typical propagation delay characteristics

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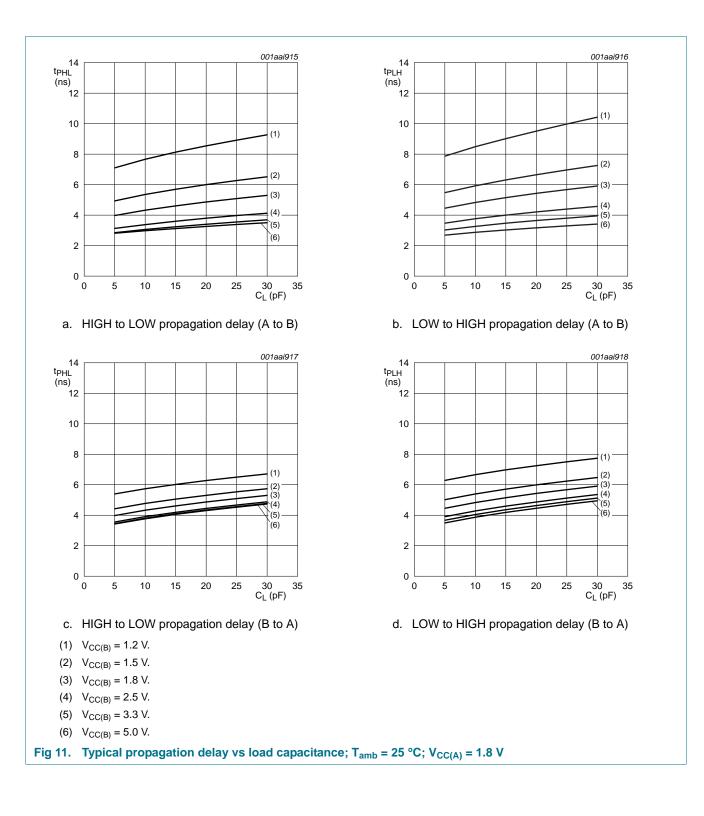
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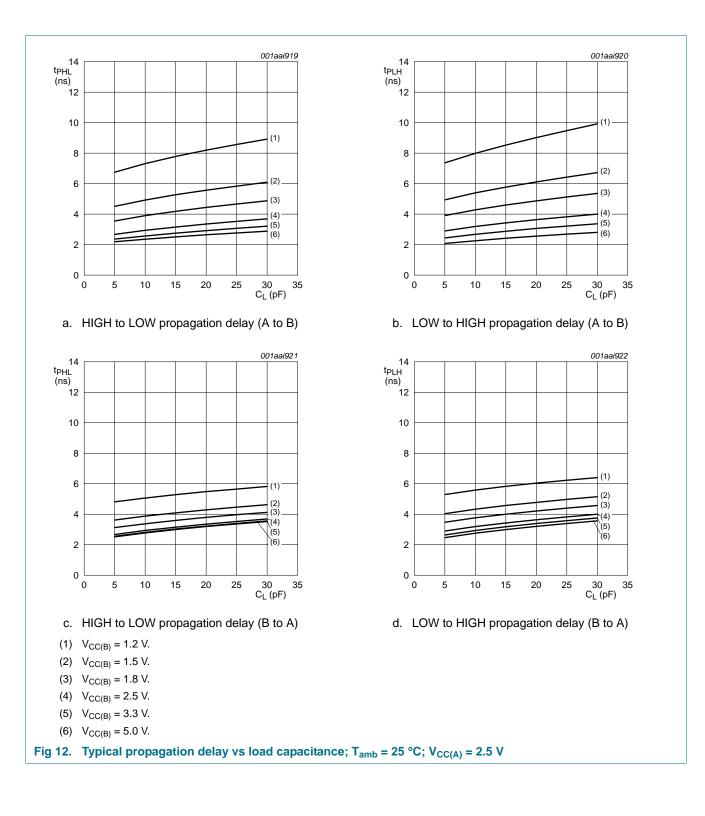
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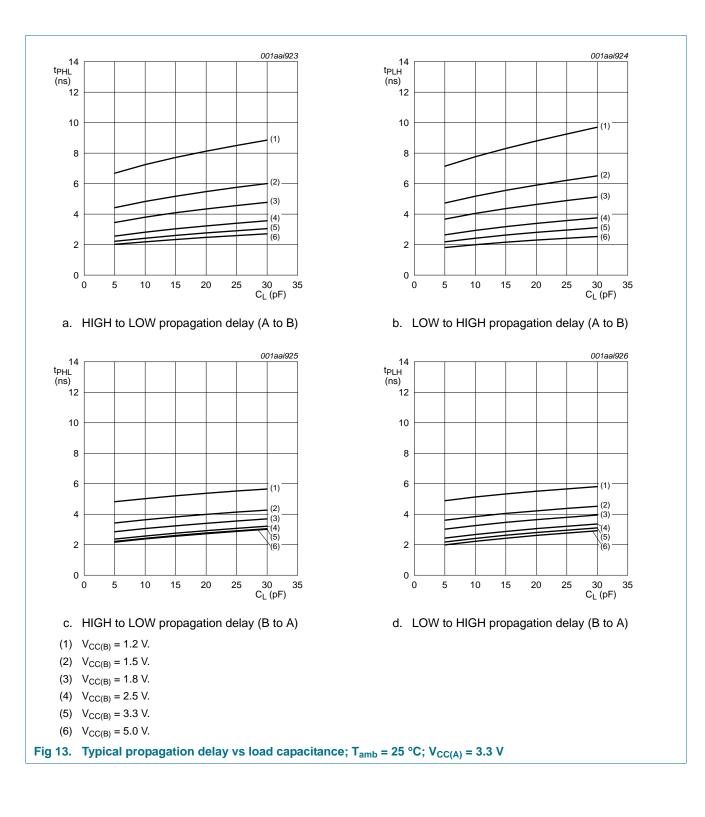
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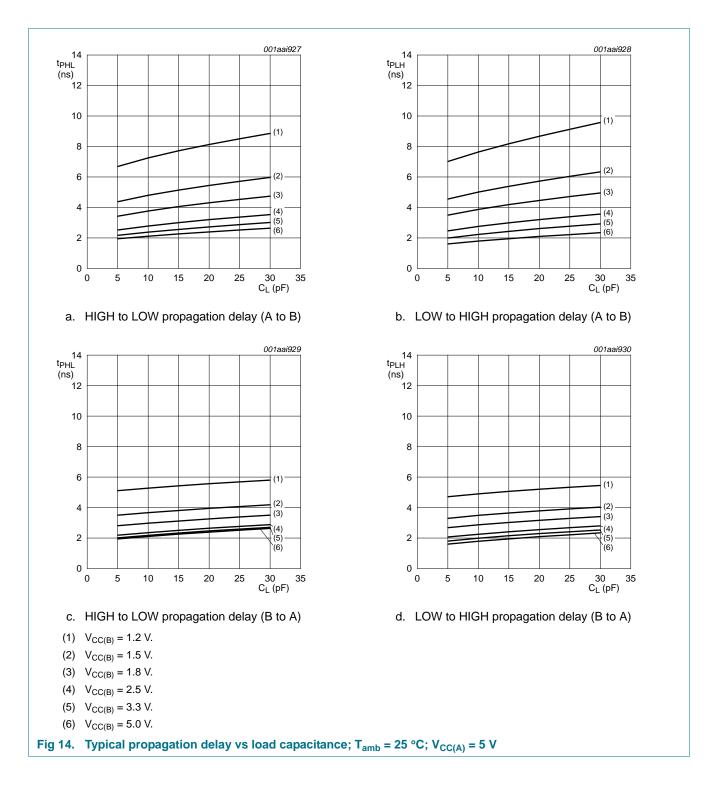
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14. Application information

14.1 Unidirectional logic level-shifting application

The circuit given in <u>Figure 15</u> is an example of the 74LVC1T45; 74LVCH1T45 being used in a unidirectional logic level-shifting application.

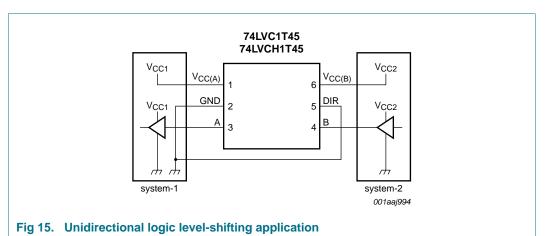


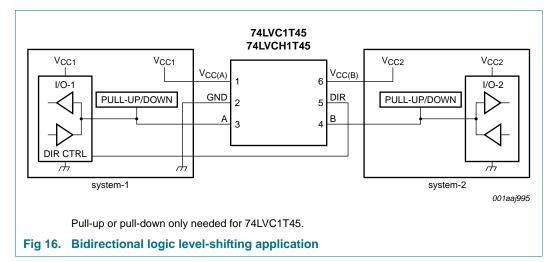
Table 16. Description unidirectional logic level-shifting application

	-		• • • • •
Pin	Name	Function	Description
1	V _{CC(A)}	V _{CC1}	supply voltage of system-1 (1.2 V to 5.5 V)
2	GND	GND	device GND
3	А	OUT	output level depends on V_{CC1} voltage
4	В	IN	input threshold value depends on V_{CC2} voltage
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	V _{CC(B)}	V _{CC2}	supply voltage of system-2 (1.2 V to 5.5 V)

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14.2 Bidirectional logic level-shifting application

Figure 16 shows the 74LVC1T45; 74LVCH1T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.



<u>Table 17</u> provides a sequence that illustrates data transmission from system-1 to system-2 and then from system-2 to system-1.

State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Η	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 are still disabled. The bus-line state depends on bus hold.
4	L	input	output	system-2 data to system-1

Table 17. Description bidirectional logic level-shifting application^[1]

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

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14.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

V _{CC(A)}	V _{CC(B)}	V _{CC(B)}					
	0 V	1.8 V	2.5 V	3.3 V	5.0 V		
0 V	0	< 1	< 1	< 1	< 1	μA	
1.8 V	< 1	< 2	< 2	< 2	2	μA	
2.5 V	< 1	< 2	< 2	< 2	< 2	μA	
3.3 V	< 1	< 2	< 2	< 2	< 2	μA	
5.0 V	< 1	2	< 2	< 2	< 2	μA	

Table 18. Typical total supply current (I_{CC(A)} + I_{CC(B)})

14.4 Enable times

Calculate the enable times for the 74LVC1T45; 74LVCH1T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74LVC1T45; 74LVCH1T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

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15. Package outline

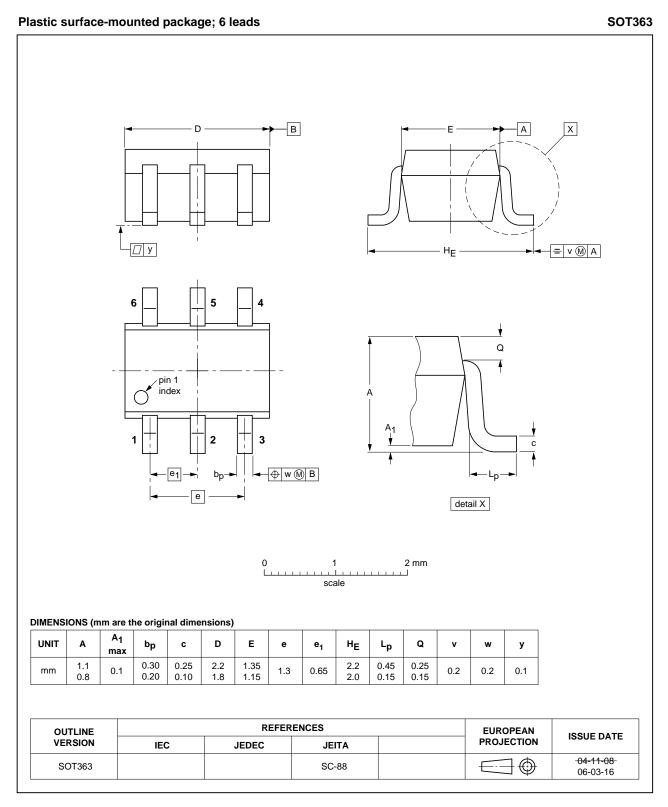


Fig 17. Package outline SOT363 (SC-88)

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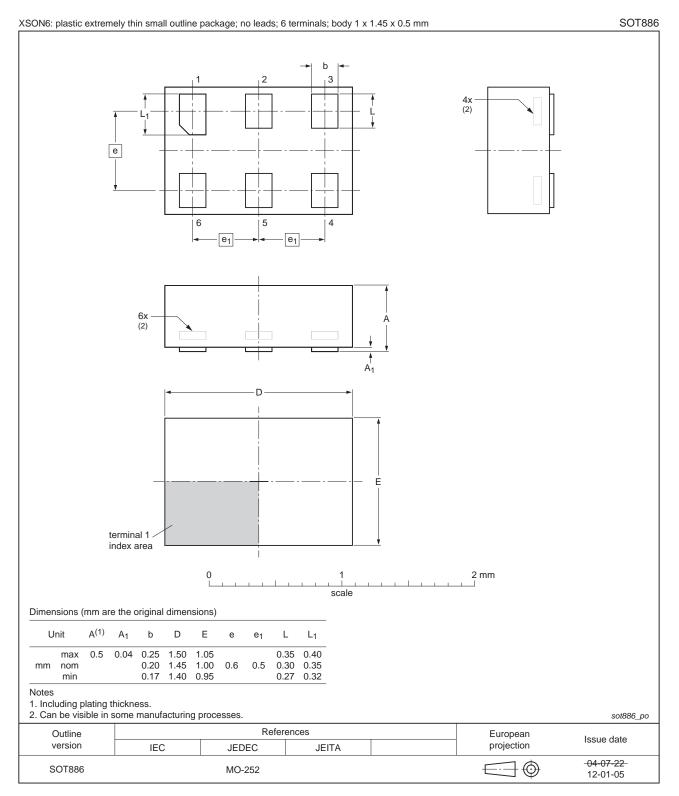


Fig 18. Package outline SOT886 (XSON6)

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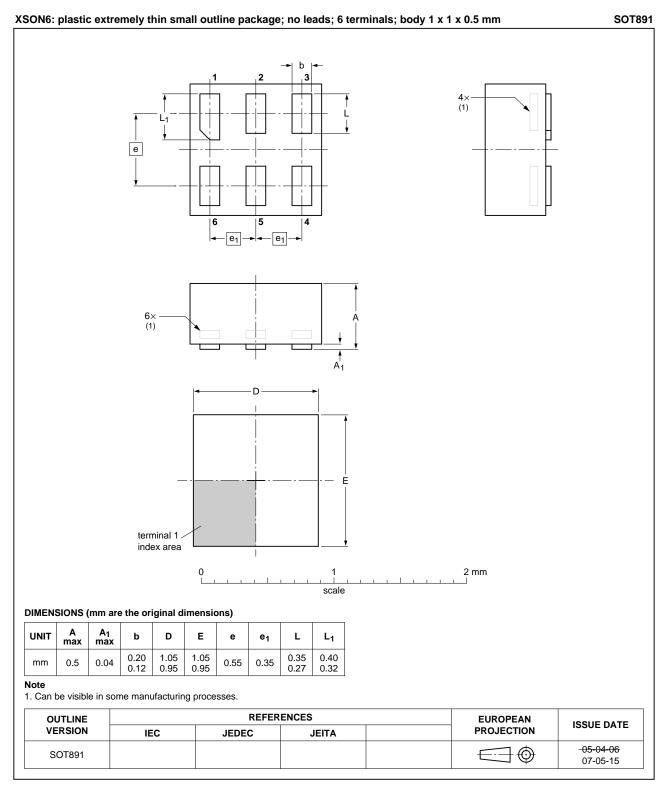
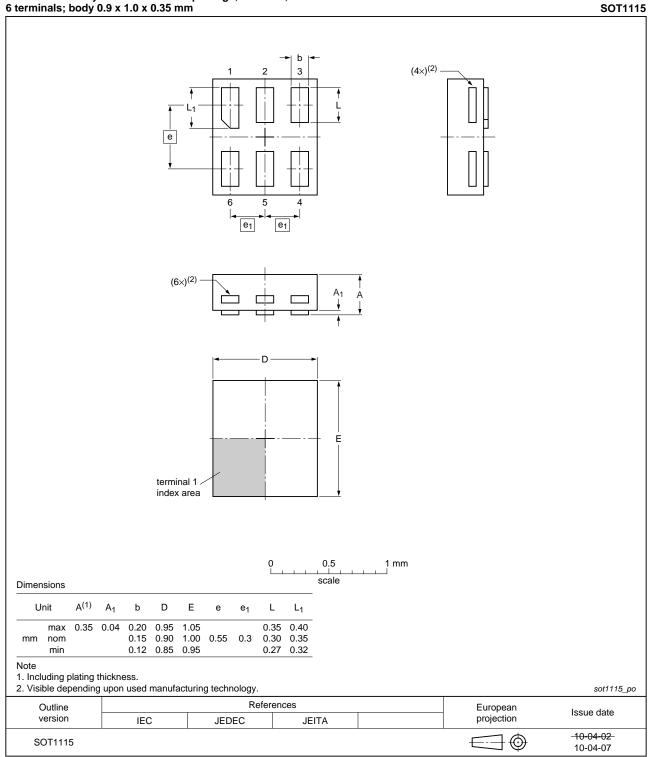


Fig 19. Package outline SOT891 (XSON6)

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XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

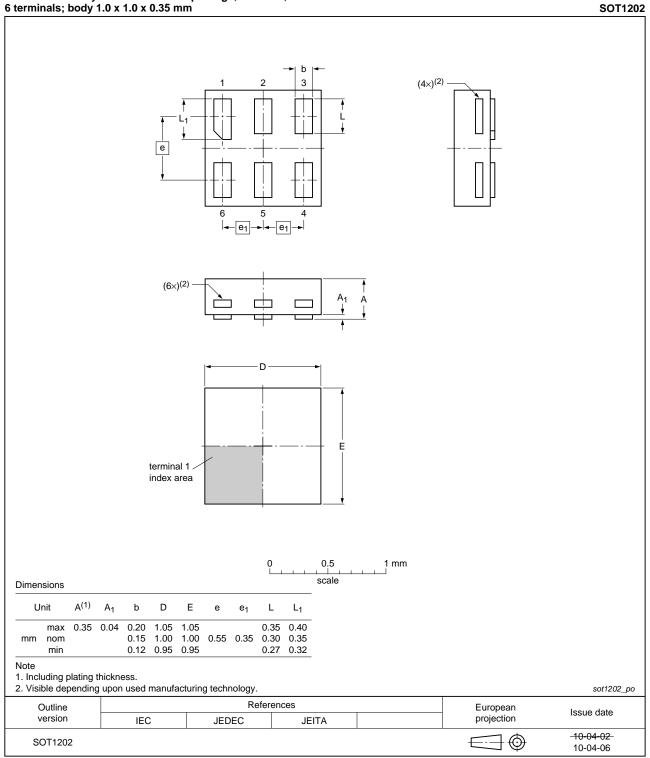
Fig 20. Package outline SOT1115 (XSON6)

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All

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XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 21. Package outline SOT1202 (XSON6)

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16. Abbreviations

Table 19. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			

17. Revision history

Table 20.Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH1T45 v.6	20120806	Product data sheet	-	74LVC_LVCH1T45 v.5
Modifications:	 Package out 	line drawing of SOT886 (<mark>Figu</mark>	re 18) modified.	
74LVC_LVCH1T45 v.5	20111219	Product data sheet	-	74LVC_LVCH1T45 v.4
Modifications:	 Legal pages 	updated.		
74LVC_LVCH1T45 v.4	20110927	Product data sheet	-	74LVC_LVCH1T45 v.3
74LVC_LVCH1T45 v.3	20100819	Product data sheet	-	74LVC_LVCH1T45 v.2
74LVC_LVCH1T45 v.2	20100119	Product data sheet	-	74LVC_LVCH1T45 v.1
74LVC_LVCH1T45 v.1	20090511	Product data sheet	-	-

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Product data sheet

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